

## **TeleSoft International Introduces CompactSIP for Windows Mobile 5.0**

AUSTIN, Texas, March 13, 2007 -- TeleSoft International today introduced a CompactSIP SDK pre-ported to Windows Mobile 5.0 with which chip makers and phone manufacturers can quickly add standards-based VoIP to wireless devices, and to mobile and wired phones.

TeleSoft will feature the CompactSIP SDK at its booth, 3443, during CTIA Wireless 2007, March 27-29, in Orlando, FL.

The CompactSIP SDK features source code running on a Pocket PC ARM emulator. It ports to the ARM processors that power many consumer and business electronics products. Using Session Internet Protocol (SIP), telephony becomes another web application, making it easy to build email, instant messaging, e-commerce, video, multimedia, navigation, soft-phone and other broadband Internet applications into SmartPhones, Feature Phones, PDAs, Pocket PCs, EDGE & EV-DO datacards, handsets, media players and other business and personal devices.

Tested over three years to ensure compliance and interoperability with industry standards and real-world operation, applications for the CompactSIP already include WiFi phones, media chips, gateways, set-top boxes, ATAs that turn traditional telephones into IP devices, and IP phones.

As small as 63KB, TeleSoft's CompactSIP is the industry's leanest SIP stack -- ideal for applications that require the smallest memory

footprint, long battery life, highest performance, and fastest path to market. In addition to Windows Mobile 5.0, it supports Nucleus, Linux, VxWorks, MQX, Micrium, uCLinux, Windows CE and other operating systems.

## About TeleSoft International

TeleSoft, [www.telesoft-intl.com](http://www.telesoft-intl.com), develops and licenses digital communications protocol source code stacks and reference designs that embed VoIP, telecomm and datacomm capabilities into consumer electronics and business systems. The company's compliance-tested, OS-independent stacks include CompactSIP, 3GPP/IMS CompactSIP, PRI & BRI ISDN, QSIG, ML-PPP, PPP, T1 Robbed Bit, E1 CAS R2, Frame Relay, X.25 and more. TeleSoft products accelerate time-to-market, minimize technology risk, and decrease the cost of both product development and product maintenance. TeleSoft's worldwide base of more than 230 customers includes, among others, AT&T, Cisco, D-Link, 3Com, Fujitsu, GTE, GenBand, IBM, Innomedia, Intel, Italtel, Lucent, Multi-Tech, NEC, NTT, Philips Electronics, Polycom, TelcoBridges, US Robotics, Vertical Communications and ZyXEL Communications.